

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SAMUEL A. WICKLINE	12/14/2016
JACOB W. MYERSON	11/14/2016
HUA PAN	01/10/2017
ROHUN PALEKAR	11/14/2016
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Property Type	Number
Application Number:	15334108
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SIGNATURE:	/Christina M. Spencer/
DATE SIGNED:	03/07/2017
Total Attachments: 3	
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Washington University Reference No 009307-CIP1/1

ASSIGNMENT AGREEMENT

ASSIGNORS:

Jacob W. Myerson
Samuel A. Wickline
Hua Pan
Rohun Palekar

WHEREAS, the aforementioned individuals (the "ASSIGNORS") have invented certain new and useful apparatus, methods, compositions, inventions, discoveries and/or improvements disclosed in U.S Patent Application Serial No. 15/334,108, filed 10/25/16 and entitled "Antithrombotic Nanoparticle";

AND WHEREAS, Washington University, having an address located at One Brookings Drive, St. Louis, Missouri 63130 (hereinafter the "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application(s) and the apparatus, inventions, discoveries, methods, compositions, and improvements therein disclosed;

NOW THEREFORE, for \$1 and other good and valuable consideration paid to us by said Assignee, including certain rights to share in royalties and other payments in accordance with Assignee's intellectual property policy, receipt whereof we hereby acknowledge, we do hereby assign, sell, transfer, and set over unto said Assignee the entire right, title, and interest in and to said application(s) and the apparatus, methods, compositions, inventions, discoveries and improvements therein disclosed for the United States of America and its territories and all foreign countries and any Letters Patent which may issue therefor in the United States and its territories and all foreign countries and all divisions, reissues, continuations, continuations-in-part, renewals, and/or extensions thereof, including the right to apply for Letters Patents in each foreign country and the United States of America and its territories, in its own name and to claim any and all priority rights under the International Convention, other conventions, treaties, or otherwise associated therewith for each country and the United States of America and its territories, said Assignee to have and to hold the interests herein assigned to the full ends of the terms of said Letters Patent and any and all divisions, reissues, continuations, continuations-in-part, renewals, and/or extensions thereof, respectively, as fully and entirely as the same would have been held and enjoyed by us had this Assignment not been made.

The U.S. Patent and Trademark Office is requested to issue such Letters Patent in accordance herewith. We covenant that we are the lawful owners of the said application(s), apparatus, methods, compositions, inventions, discoveries and improvements, that the same are unencumbered, that no license has been granted to make, use, or sell the said apparatus, methods, compositions, inventions, discoveries or improvements, and that we have the full right to make this Assignment.

Patent Assignment [04-04-17]

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And for said consideration, we agree individually that we will communicate to said Assignee or the representatives thereof any facts known to me respecting said apparatus, methods, compositions, inventions, discoveries and improvements, and will, upon request, but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal, and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts, deemed necessary or expedient by said Assignee or by counsel for said Assignee, to assist or enable said Assignee to obtain and enforce full benefits from the rights and interests herein assigned.

And for said consideration, the undersigned hereby agrees to execute, at the request of said Assignee, all documents in connection with any application for foreign letters patent therefor.

Assignors hereby grant to Assignee and its agents and attorneys the power and right to insert herein the title, serial number and filing date of the application, the OTM case number and title of the application after this Assignment is executed by the Assignors.

This Assignment shall be binding upon our heirs, executors, administrators, and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors, and/or assigns, as the case may be, of said Assignee.

Date: 11/14/2016

DocuSigned by:

E20DC000C0CB44E

Jacob W. Myerson

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Washington University Reference No 009307-CIP1/1

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Accepted on behalf of the Assignee: Washington University

DocuSigned by:
Nichole Mercier

Signature, Managing Director Technology Management

1/10/2017

Date

Patent Assignment 04-04-17